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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Attn: OIPE

Masakazu SATO et al.

Application No.: 10/517,655

Docket No.: 122035

Filed: December 13, 2004

For: METHOD OF EVALUATING SHAPE OF SEMICONDUCTOR WAFER AND
APPARATUS FOR EVALUATING SHAPE OF SEMICONDUCTOR WAFER

REQUEST FOR CORRECTION OF PALM RECORDS

Commissioner for Patents
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Sir:

Attached is a photocopy of the original filing receipt on which errors have been corrected in red. These errors are being brought to the attention of the Patent and Trademark Office so that it may correct its records.

Respectfully submitted,

William P. Berridge
Registration No. 30,024

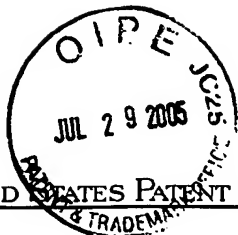
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WPB:JOC/emt

Date: July 29, 2005

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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/517,655	12/13/2004	2812	6600	122035	8	132	2

CONFIRMATION NO. 7281

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FILING RECEIPT



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Applicant(s)

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Assignment For Published Patent Application

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Power of Attorney: The patent practitioners associated with Customer Number 25944.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/07320 06/10/2003

Foreign Applications

JAPAN 2002173268 06/11/2002

Projected Publication Date: 09/22/2005

Non-Publication Request: No

Early Publication Request: No

Title

~~Semiconductor wafer shape evaluating method and shape evaluating device~~

Preliminary Class 438 Method of Evaluating Shape of Semiconductor Wafer and Apparatus for Evaluating Shape of Semiconductor Wafer

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